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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	18144
Number of Logic Elements/Cells	-
Total RAM Bits	165888
Number of I/O	516
Number of Gates	1000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 85°C (TA)
Package / Case	896-BGA
Supplier Device Package	896-FBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/microsemi/ax1000-1fg896i

Figure 1-8 • AX Routing Structures

Global Resources

Each family member has three types of global signals available to the designer: HCLK, CLK, and GCLR/GPSET. There are four hardwired clocks (HCLK) per device that can directly drive the clock input of each R-cell. Each of the four routed clocks (CLK) can drive the clock, clear, preset, or enable pin of an R-cell or any input of a C-cell (Figure 1-3 on page 1-2).

Global clear (GCLR) and global preset (GPSET) drive the clear and preset inputs of each R-cell as well as each I/O Register on a chip-wide basis at power-up.

Each HCLK and CLK has an associated analog PLL (a total of eight per chip). Each embedded PLL can be used for clock delay minimization, clock delay adjustment, or clock frequency synthesis. The PLL is capable of operating with input frequencies ranging from 14 MHz to 200 MHz and can generate output frequencies between 20 MHz and 1 GHz. The clock can be either divided or multiplied by factors ranging from 1 to 64. Additionally, multiply and divide settings can be used in any combination as long as the resulting clock frequency is between 20 MHz and 1 GHz. Adjacent PLLs can be cascaded to create complex frequency combinations.

The PLL can be used to introduce either a positive or a negative clock delay of up to 3.75 ns in 250 ps increments. The reference clock required to drive the PLL can be derived from three sources: external input pad (either single-ended or differential), internal logic, or the output of an adjacent PLL.

Low Power (LP) Mode

The AX architecture was created for high-performance designs but also includes a low power mode (activated via the LP pin). When the low power mode is activated, I/O banks can be disabled (inputs disabled, outputs tristated), and PLLs can be placed in a power-down mode. All internal register states are maintained in this mode. Furthermore, individual I/O banks can be configured to opt out of the LP mode, thereby giving the designer access to critical signals while the rest of the chip is in low power mode.

The power can be further reduced by providing an external voltage source (V_{PUMP}) to the device to bypass the internal charge pump (See "Low Power Mode" on page 2-106 for more information).

Table 2-22 • 3.3 V LVTTTL I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C (continued)

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
LVTTTL Output Drive Strength = 2 (12 mA) / Low Slew Rate								
t _{DP}	Input Buffer		1.68		1.92		2.26	ns
t _{PY}	Output Buffer		12.14		13.83		16.26	ns
t _{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		12.43		14.16		16.65	ns
t _{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		12.17		13.86		16.30	ns
t _{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		1.73		1.74		1.75	ns
t _{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		2.22		2.23		2.24	ns
t _{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t _{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.38		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

1.5 V LVCMOS (JESD8-11)

Low-Voltage Complementary Metal-Oxide Semiconductor for 1.5 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 1.5 V applications. It uses a 3.3 V tolerant CMOS input buffer and a push-pull output buffer.

Table 2-29 • DC Input and Output Levels

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	Max., V	Min., V	Max., V	Max., V	Min., V	mA	mA
-0.3	0.35 VCCI	0.65 VCCI	3.6	0.4	VCCI - 0.4	8 mA	-8 mA

AC Loadings

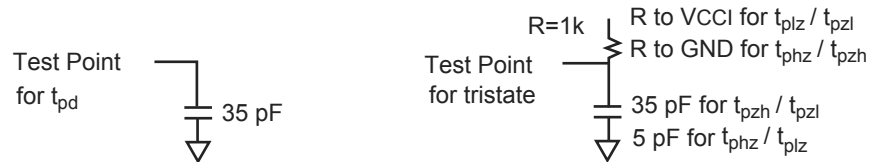


Table 2-30 • AC Test Loads

Table 2-31 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C _{load} (pF)
0	1.5	0.5V _{CCI}	N/A	35

Note: * Measuring Point = VTRIP

Timing Characteristics

Table 2-32 • 1.5V LVCMOS I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 1.4 V, TJ = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
LVCMOS15 (JESD8-11) I/O Module Timing								
t _{DP}	Input Buffer		3.59		4.09		4.81	ns
t _{PY}	Output Buffer		6.05		6.89		8.10	ns
t _{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		3.31		3.34		3.34	ns
t _{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		4.56		4.58		4.59	ns
t _{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		6.37		7.25		8.52	ns
t _{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		6.94		7.90		9.29	ns
t _{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t _{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Differential Standards

Physical Implementation

Implementing differential I/O standards requires the configuration of a pair of external I/O pads, resulting in a single internal signal. To facilitate construction of the differential pair, a single I/O Cluster contains the resources for a pair of I/Os. Configuration of the I/O Cluster as a differential pair is handled by Designer software when the user instantiates a differential I/O macro in the design.

Differential I/Os can also be used in conjunction with the embedded Input Register (InReg), Output Register (OutReg), Enable Register (EnReg), and Double Data Rate (DDR). However, there is no support for bidirectional I/Os or tristates with these standards.

LVDS

Low-Voltage Differential Signal (ANSI/TIA/EIA-644) is a high-speed, differential I/O standard. It requires that one data bit is carried through two signal lines, so two pins are needed. It also requires an external resistor termination. The voltage swing between these two signal lines is approximately 350 mV.

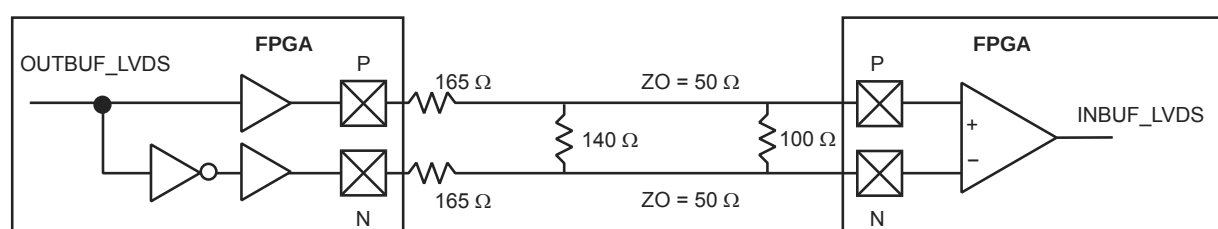


Figure 2-25 • LVDS Board-Level Implementation

The LVDS circuit consists of a differential driver connected to a terminated receiver through a constant-impedance transmission line. The receiver is a wide-common-mode-range differential amplifier. The common-mode range is from 0.2 V to 2.2 V for a differential input with 400 mV swing.

To implement the driver for the LVDS circuit, drivers from two adjacent I/O cells are used to generate the differential signals (note that the driver is not a current-mode driver). This driver provides a nominal constant current of 3.5 mA. When this current flows through a 100 Ω termination resistor on the receiver side, a voltage swing of 350 mV is developed across the resistor. The direction of the current flow is controlled by the data fed to the driver.

An external-resistor network (three resistors) is needed to reduce the voltage swing to about 350 mV. Therefore, four external resistors are required, three for the driver and one for the receiver.

Table 2-56 • DC Input and Output Levels

DC Parameter	Description	Min.	Typ.	Max.	Units
VCCI ¹	Supply Voltage	2.375	2.5	2.625	V
VOH	Output High Voltage	1.25	1.425	1.6	V
VOL	Output Low Voltage	0.9	1.075	1.25	V
VODIFF	Differential Output Voltage	250	350	450	mV
VOCM	Output Common Mode Voltage	1.125	1.25	1.375	V
VICM2	Input Common Mode Voltage	0.2	1.25	2.2	V

Notes:

1. $\pm 5\%$
2. Differential input voltage = ± 350 mV.

Buffer Module

Introduction

An additional resource inside each SuperCluster is the Buffer (B) module (Figure 1-4 on page 1-3). When a fanout constraint is applied to a design, the synthesis tool inserts buffers as needed. The buffer module has been added to the AX architecture to avoid logic duplication resulting from the hard fanout constraints. The router utilizes this logic resource to save area and reduce loading and delays on medium-to-high-fanout nets.

Timing Models and Waveforms

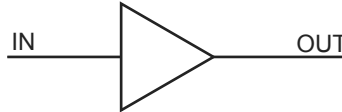


Figure 2-33 • Buffer Module Timing Model

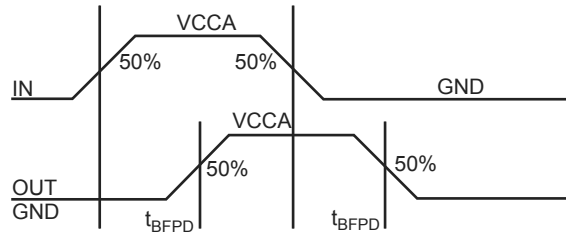


Figure 2-34 • Buffer Module Waveform

Timing Characteristics

Table 2-64 • Buffer Module

Worst-Case Commercial Conditions $V_{CCA} = 1.425\text{ V}$, $V_{CCI} = 3.0\text{ V}$, $T_j = 70^\circ\text{C}$

		-2 Speed		-1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
Buffer Module Propagation Delays								
t_{BFPD}	Any input to output Y		0.12		0.14		0.16	ns

Routed Clocks

The routed clock (CLK) is a low-skew network that can drive the clock inputs of all sequential modules in the device (logically equivalent to the HCLK), but has the added flexibility in that it can drive the S0 (Enable), S1, PSET, and CLR input of a register (R-cells and I/O registers) as well as any of the inputs of any C-cell in the device. This allows CLKs to be used not only as clocks, but also for other global signals or high fanout nets. All four CLKs are available everywhere on the chip.

Timing Characteristics

Table 2-75 • AX125 Routed Array Clock Networks

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		Units
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	
Routed Array Clock Networks								
t _{RCKL}	Input Low to High		3.08		3.50		4.12	ns
t _{RCKH}	Input High to Low		3.13		3.56		4.19	ns
t _{RPWH}	Minimum Pulse Width High	0.57		0.64		0.75		ns
t _{RPWL}	Minimum Pulse Width Low	0.52		0.59		0.69		ns
t _{RCKSW}	Maximum Skew		0.35		0.39		0.46	ns
t _{RP}	Minimum Period	1.15		1.31		1.54		ns
t _{RMAX}	Maximum Frequency		870		763		649	MHz

Table 2-76 • AX250 Routed Array Clock Networks

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		Units
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	
Routed Array Clock Networks								
t _{RCKL}	Input Low to High		2.52		2.87		3.37	ns
t _{RCKH}	Input High to Low		2.59		2.95		3.47	ns
t _{RPWH}	Minimum Pulse Width High	0.57		0.64		0.75		ns
t _{RPWL}	Minimum Pulse Width Low	0.52		0.59		0.69		ns
t _{RCKSW}	Maximum Skew		0.35		0.39		0.46	ns
t _{RP}	Minimum Period	1.15		1.31		1.54		ns
t _{RMAX}	Maximum Frequency		870		763		649	MHz

Table 2-89 • One RAM Block

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		Units
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	
Write Mode								
t _{WDASU}	Write Data Setup vs. WCLK		1.08		1.23		1.45	ns
t _{WDAHD}	Write Data Hold vs. WCLK		0.22		0.25		0.30	ns
t _{WADSU}	Write Address Setup vs. WCLK		1.08		1.23		1.45	ns
t _{WADHD}	Write Address Hold vs. WCLK		0.00		0.00		0.00	ns
t _{WENSU}	Write Enable Setup vs. WCLK		1.08		1.23		1.45	ns
t _{WENHD}	Write Enable Hold vs. WCLK		0.22		0.25		0.30	ns
t _{WCKH}	WCLK Minimum High Pulse Width	0.75		0.75		0.75		ns
t _{WCLK}	WCLK Minimum Low Pulse Width	0.88		0.88		0.88		ns
t _{WCKP}	WCLK Minimum Period	1.63		1.63		1.63		ns
Read Mode								
t _{RADSU}	Read Address Setup vs. RCLK		0.81		0.92		1.08	ns
t _{RADHD}	Read Address Hold vs. RCLK		0.00		0.00		0.00	ns
t _{RENSU}	Read Enable Setup vs. RCLK		0.81		0.92		1.08	ns
t _{RENHD}	Read Enable Hold vs. RCLK		0.00		0.00		0.00	ns
t _{RCK2RD1}	RCLK-to-OUT (Pipelined)		1.32		1.51		1.77	ns
t _{RCK2RD2}	RCLK-to-OUT (Non-Pipelined)		2.16		2.46		2.90	ns
t _{RCLKH}	RCLK Minimum High Pulse Width	0.77		0.77		0.77		ns
t _{RCLKL}	RCLK Minimum Low Pulse Width	0.93		0.93		0.93		ns
t _{RCKP}	RCLK Minimum Period	1.70		1.70		1.70		ns

Note: Timing data for this single block RAM has a depth of 4,096. For all other combinations, use Microsemi's timing software.

BG729		BG729		BG729	
AX1000 Function	Pin Number	AX1000 Function	Pin Number	AX1000 Function	Pin Number
IO163PB5F15	AA14	IO182NB5F17	AF7	IO200NB6F18	AA4
IO164NB5F15	AE13	IO182PB5F17	AG7	IO200PB6F18	AA5
IO164PB5F15	AF13	IO183NB5F17	AD7	IO201NB6F18	W5
IO165NB5F15	AF12	IO183PB5F17	AE7	IO201PB6F18	W6
IO165PB5F15	AG12	IO184NB5F17	AC7	IO202NB6F18	AB1
IO166NB5F15	AD12	IO184PB5F17	AC8	IO202PB6F18	AC1
IO166PB5F15	AE12	IO185NB5F17	AF6	IO203NB6F19	Y3
IO167NB5F15	Y13	IO185PB5F17	AG6	IO203PB6F19	AA3
IO167PB5F15	AA13	IO186NB5F17	AB7	IO204NB6F19	AA2
IO168NB5F15	AD11	IO186PB5F17	AB8	IO204PB6F19	AB2
IO168PB5F15	AE11	IO187NB5F17	Y9	IO205NB6F19	U8
IO169NB5F15	AG11	IO187PB5F17	AA9	IO205PB6F19	V8
IO169PB5F15	AF11	IO188NB5F17	AD6	IO206NB6F19	V5
IO170NB5F15	AB11	IO188PB5F17	AE6	IO206PB6F19	V6
IO170PB5F15	AC11	IO189NB5F17	AB6	IO207NB6F19	Y1
IO171NB5F16	AF10	IO189PB5F17	AC6	IO207PB6F19	AA1
IO171PB5F16	AG10	IO190NB5F17	AF5	IO208NB6F19	W4
IO172NB5F16	AD10	IO190PB5F17	AG5	IO208PB6F19	Y4
IO172PB5F16	AE10	IO191NB5F17	AA6	IO209NB6F19	T7
IO173NB5F16	Y12	IO191PB5F17	AA7	IO209PB6F19	U7
IO173PB5F16	AA12	IO192NB5F17	Y8	IO210NB6F19	W2
IO174NB5F16	AB10	IO192PB5F17	AA8	IO210PB6F19	Y2
IO174PB5F16	AC10	Bank 6		IO211NB6F19	U5
IO175NB5F16	AF9	IO193NB6F18	W8	IO211PB6F19	U6
IO175PB5F16	AG9	IO193PB6F18	Y7	IO212NB6F19	V3
IO176NB5F16	AD9	IO194NB6F18	AB5	IO212PB6F19	W3
IO176PB5F16	AE9	IO194PB6F18	AC5	IO213NB6F19	R9
IO177NB5F16	Y11	IO195NB6F18	AC2	IO213PB6F19	T8
IO177PB5F16	AA11	IO195PB6F18	AC3	IO214NB6F20	U4
IO178NB5F16	AF8	IO196NB6F18	AC4	IO214PB6F20	V4
IO178PB5F16	AG8	IO196PB6F18	AD4	IO215NB6F20	T5
IO179NB5F16	AD8	IO197NB6F18	Y5	IO215PB6F20	T6
IO179PB5F16	AE8	IO197PB6F18	Y6	IO216NB6F20	V1
IO180NB5F16	AB9	IO198NB6F18	AB3	IO216PB6F20	W1
IO180PB5F16	AC9	IO198PB6F18	AB4	IO217NB6F20	R7
IO181NB5F17	Y10	IO199NB6F18	V7	IO217PB6F20	R8
IO181PB5F17	AA10	IO199PB6F18	W7	IO218NB6F20	U2

BG729	
AX1000 Function	Pin Number
IO218PB6F20	V2
IO219NB6F20	T1
IO219PB6F20	U1
IO220NB6F20	R5
IO220PB6F20	R6
IO221NB6F20	T3
IO221PB6F20	T4
IO222NB6F20	R2
IO222PB6F20	T2
IO223NB6F20	P8
IO223PB6F20	P9
IO224NB6F20	R3
IO224PB6F20	R4
Bank 7	
IO225NB7F21	P1
IO225PB7F21	R1
IO226NB7F21	P3
IO226PB7F21	P2
IO227NB7F21	N7
IO227PB7F21	P7
IO228NB7F21	P5
IO228PB7F21	P4
IO229NB7F21	N2
IO229PB7F21	N1
IO230NB7F21	N6
IO230PB7F21	P6
IO231NB7F21	N9
IO231PB7F21	N8
IO232NB7F21	N4
IO232PB7F21	N3
IO233NB7F21	M2
IO233PB7F21	M1
IO234NB7F21	M4
IO234PB7F21	M3
IO235NB7F21	M5
IO235PB7F21	N5
IO236NB7F22	L2

BG729	
AX1000 Function	Pin Number
IO236PB7F22	L1
IO237NB7F22	L4
IO237PB7F22	L3
IO238NB7F22	L6
IO238PB7F22	M6
IO239NB7F22	M8
IO239PB7F22	M7
IO240NB7F22	K2
IO240PB7F22	K1
IO241NB7F22	K4
IO241PB7F22	K3
IO242NB7F22	K5
IO242PB7F22	L5
IO243NB7F22	J2
IO243PB7F22	J1
IO244NB7F22	J4
IO244PB7F22	J3
IO245NB7F22	H2
IO245PB7F22	H1
IO246NB7F22	H4
IO246PB7F22	H3
IO247NB7F23	L8
IO247PB7F23	L7
IO248NB7F23	J6
IO248PB7F23	K6
IO249NB7F23	H5
IO249PB7F23	J5
IO250NB7F23	G2
IO250PB7F23	G1
IO251NB7F23	K8
IO251PB7F23	K7
IO252NB7F23	G4
IO252PB7F23	G3
IO253NB7F23	F2
IO253PB7F23	F1
IO254NB7F23	G6
IO254PB7F23	H6

BG729	
AX1000 Function	Pin Number
IO255NB7F23	F5
IO255PB7F23	G5
IO256NB7F23	F3
IO256PB7F23	F4
IO257NB7F23	H7
IO257PB7F23	J7
Dedicated I/O	
GND	A1
GND	A2
GND	A25
GND	A26
GND	A27
GND	A3
GND	AC24
GND	AE1
GND	AE2
GND	AE25
GND	AE26
GND	AE27
GND	AE3
GND	AE5
GND	AF1
GND	AF2
GND	AF25
GND	AF26
GND	AF27
GND	AF3
GND	AG1
GND	AG2
GND	AG25
GND	AG26
GND	AG27
GND	AG3
GND	B1
GND	B2
GND	B25
GND	B26

FG484		FG484		FG484	
AX250 Function	Pin Number	AX250 Function	Pin Number	AX250 Function	Pin Number
Bank 0		IO17NB1F1	B14	IO34PB2F2	D22
IO00NB0F0	D7	IO17PB1F1	B13	IO35NB2F2	J18
IO00PB0F0	D6	IO18NB1F1	A14	IO35PB2F2	H18
IO01NB0F0	E7	IO18PB1F1	A13	IO36NB2F2	G21
IO01PB0F0	E6	IO19NB1F1	A16	IO36PB2F2	F21
IO02NB0F0	C5	IO19PB1F1	A15	IO37NB2F2	K19
IO02PB0F0	C4	IO20NB1F1	B16	IO37PB2F2	J19
IO03NB0F0	C7	IO20PB1F1	B15	IO38NB2F2	J20
IO03PB0F0	C6	IO21NB1F1	C17	IO38PB2F2	H20
IO04NB0F0	E9	IO21PB1F1	C16	IO39NB2F2	L16
IO04PB0F0	E8	IO22NB1F1	F15	IO39PB2F2	K16
IO05NB0F0	D9	IO22PB1F1	F14	IO40NB2F2	J21
IO05PB0F0	D8	IO23NB1F1	D16	IO40PB2F2	H21
IO06NB0F0	B7	IO23PB1F1	D15	IO41NB2F2	L17
IO06PB0F0	B6	IO24NB1F1	E16	IO41PB2F2	K17
IO07NB0F0	C9	IO24PB1F1	E15	IO42NB2F2	J22
IO07PB0F0	C8	IO25NB1F1	F18	IO42PB2F2	H22
IO08NB0F0	A7	IO25PB1F1	F17	IO43NB2F2	L18
IO08PB0F0	A6	IO26NB1F1	D18	IO43PB2F2	K18
IO09NB0F0	B9	IO26PB1F1	E17	IO44NB2F2	L20
IO09PB0F0	B8	IO27NB1F1	G16	IO44PB2F2	K20
IO10NB0F0	A9	IO27PB1F1	G15	Bank 3	
IO10PB0F0	A8	Bank 2		IO45NB3F3	M19
IO11NB0F0	B10	IO28NB2F2	F19	IO45PB3F3	L19
IO11PB0F0	A10	IO28PB2F2	E19	IO46NB3F3	M21
IO12NB0F0/HCLKAN	E11	IO29NB2F2	J16	IO46PB3F3	L21
IO12PB0F0/HCLKAP	E10	IO29PB2F2	H16	IO47NB3F3	N17
IO13NB0F0/HCLKBN	D12	IO30NB2F2	E20	IO47PB3F3	M17
IO13PB0F0/HCLKBP	D11	IO30PB2F2	D20	IO48NB3F3	N18
Bank 1		IO31NB2F2	J17	IO48PB3F3	N19
IO14NB1F1/HCLKCN	F13	IO31PB2F2	H17	IO49NB3F3	N16
IO14PB1F1/HCLKCP	F12	IO32NB2F2	G20	IO49PB3F3	M16
IO15NB1F1/HCLKDN	E14	IO32PB2F2	F20	IO50NB3F3	N20
IO15PB1F1/HCLKDP	E13	IO33NB2F2	H19	IO50PB3F3	M20
IO16NB1F1	C13	IO33PB2F2	G19	IO51NB3F3	P21
IO16PB1F1	C12	IO34NB2F2	E22	IO51PB3F3	N21

FG484	
AX500 Function	Pin Number
VCCA	P11
VCCA	P12
VCCA	P13
VCCA	T6
VCCA	U17
VCCPLA	F10
VCCPLB	G9
VCCPLC	D13
VCCPLD	G13
VCCPLE	U13
VCCPLF	T14
VCCPLG	W10
VCCPLH	T10
VCCDA	D14
VCCDA	D5
VCCDA	F16
VCCDA	G12
VCCDA	L4
VCCDA	M18
VCCDA	T11
VCCDA	T17
VCCDA	U7
VCCDA	V14
VCCDA	V8
VCCIB0	A3
VCCIB0	B3
VCCIB0	H10
VCCIB0	H11
VCCIB0	H9
VCCIB1	A20
VCCIB1	B20
VCCIB1	H12
VCCIB1	H13
VCCIB1	H14
VCCIB2	C21

FG484	
AX500 Function	Pin Number
VCCIB2	C22
VCCIB2	J15
VCCIB2	K15
VCCIB2	L15
VCCIB3	M15
VCCIB3	N15
VCCIB3	P15
VCCIB3	Y21
VCCIB3	Y22
VCCIB4	AA20
VCCIB4	AB20
VCCIB4	R12
VCCIB4	R13
VCCIB4	R14
VCCIB5	AA3
VCCIB5	AB3
VCCIB5	R10
VCCIB5	R11
VCCIB5	R9
VCCIB6	M8
VCCIB6	N8
VCCIB6	P8
VCCIB6	Y1
VCCIB6	Y2
VCCIB7	C1
VCCIB7	C2
VCCIB7	J8
VCCIB7	K8
VCCIB7	L8
VCOMPLA	D10
VCOMPLB	G10
VCOMPLC	E12
VCOMPLD	G14
VCOMPLE	W13
VCOMPLF	T13

FG484	
AX500 Function	Pin Number
VCOMPLG	V11
VCOMPLH	T9
VPUMP	D17

FG484		FG484		FG484	
AX1000 Function	Pin Number	AX1000 Function	Pin Number	AX1000 Function	Pin Number
IO246NB7F22	F3	GND	D4	GND	V5
IO246PB7F22	G3	GND	E18	GND	W19
IO250NB7F23	F4	GND	E5	GND	W4
IO250PB7F23	G4	GND	G18	GND	Y20
IO253NB7F23	G5	GND	H15	GND	Y3
IO253PB7F23	G6	GND	H8	GND/LP	G7
IO254NB7F23	D1	GND	J14	PRA	G11
IO254PB7F23	E1	GND	J9	PRB	F11
IO257NB7F23	F5	GND	K10	PRC	T12
IO257PB7F23	E4	GND	K11	PRD	U12
Dedicated I/O		GND	K12	TCK	G8
VCCDA	H7	GND	K13	TDI	F9
GND	A1	GND	L1	TDO	F7
GND	A11	GND	L10	TMS	F6
GND	A12	GND	L11	TRST	F8
GND	A2	GND	L12	VCCA	G17
GND	A21	GND	L13	VCCA	J10
GND	A22	GND	L22	VCCA	J11
GND	AA1	GND	M1	VCCA	J12
GND	AA2	GND	M10	VCCA	J13
GND	AA21	GND	M11	VCCA	J7
GND	AA22	GND	M12	VCCA	K14
GND	AB1	GND	M13	VCCA	K9
GND	AB11	GND	M22	VCCA	L14
GND	AB12	GND	N10	VCCA	L9
GND	AB2	GND	N11	VCCA	M14
GND	AB21	GND	N12	VCCA	M9
GND	AB22	GND	N13	VCCA	N14
GND	B1	GND	P14	VCCA	N9
GND	B2	GND	P9	VCCA	P10
GND	B21	GND	R15	VCCA	P11
GND	B22	GND	R8	VCCA	P12
GND	C20	GND	U16	VCCA	P13
GND	C3	GND	U6	VCCA	T6
GND	D19	GND	V18	VCCA	U17

FG676	
AX1000 Function	Pin Number
GND	A8
GND	AC23
GND	AC4
GND	AD24
GND	AD3
GND	AE2
GND	AE25
GND	AF1
GND	AF13
GND	AF14
GND	AF19
GND	AF26
GND	AF8
GND	B2
GND	B25
GND	B26
GND	C24
GND	C3
GND	G20
GND	G7
GND	H1
GND	H19
GND	H26
GND	H8
GND	J18
GND	J9
GND	K10
GND	K11
GND	K12
GND	K13
GND	K14
GND	K15
GND	K16
GND	K17
GND	L10
GND	L11

FG676	
AX1000 Function	Pin Number
GND	L12
GND	L13
GND	L14
GND	L15
GND	L16
GND	L17
GND	M10
GND	M11
GND	M12
GND	M13
GND	M14
GND	M15
GND	M16
GND	M17
GND	N1
GND	N10
GND	N11
GND	N12
GND	N13
GND	N14
GND	N15
GND	N16
GND	N17
GND	N26
GND	P1
GND	P10
GND	P11
GND	P12
GND	P13
GND	P14
GND	P15
GND	P16
GND	P17
GND	P26
GND	R10
GND	R11

FG676	
AX1000 Function	Pin Number
GND	R12
GND	R13
GND	R14
GND	R15
GND	R16
GND	R17
GND	T10
GND	T11
GND	T12
GND	T13
GND	T14
GND	T15
GND	T16
GND	T17
GND	U10
GND	U11
GND	U12
GND	U13
GND	U14
GND	U15
GND	U16
GND	U17
GND	V18
GND	V9
GND	W1
GND	W19
GND	W26
GND	W8
GND	Y20
GND	Y7
GND/LP	C2
NC	A25
NC	AC13
NC	AC14
NC	AF2
NC	AF25

FG896	
AX2000 Function	Pin Number
Bank 0	
IO00NB0F0	B4
IO00PB0F0	A4
IO01NB0F0	F8
IO01PB0F0	F7
IO02NB0F0	D6
IO02PB0F0	E6
IO04NB0F0	A5
IO04PB0F0	B5
IO05NB0F0	H8
IO05PB0F0	G8
IO06NB0F0	D7
IO06PB0F0	E7
IO07NB0F0	D8
IO07PB0F0	E8
IO08NB0F0	C7
IO08PB0F0	C6
IO09NB0F0	G9
IO09PB0F0	H9
IO10NB0F0	A6
IO10PB0F0	B6
IO11NB0F0	H10
IO11PB0F0	G10
IO12NB0F1	E9
IO12PB0F1	F9
IO13NB0F1	E10
IO13PB0F1	F10
IO15NB0F1	F11
IO15PB0F1	G11
IO16NB0F1	A7
IO16PB0F1	B7
IO17NB0F1	D10
IO17PB0F1	D9
IO18NB0F1	C9
IO18PB0F1	C8

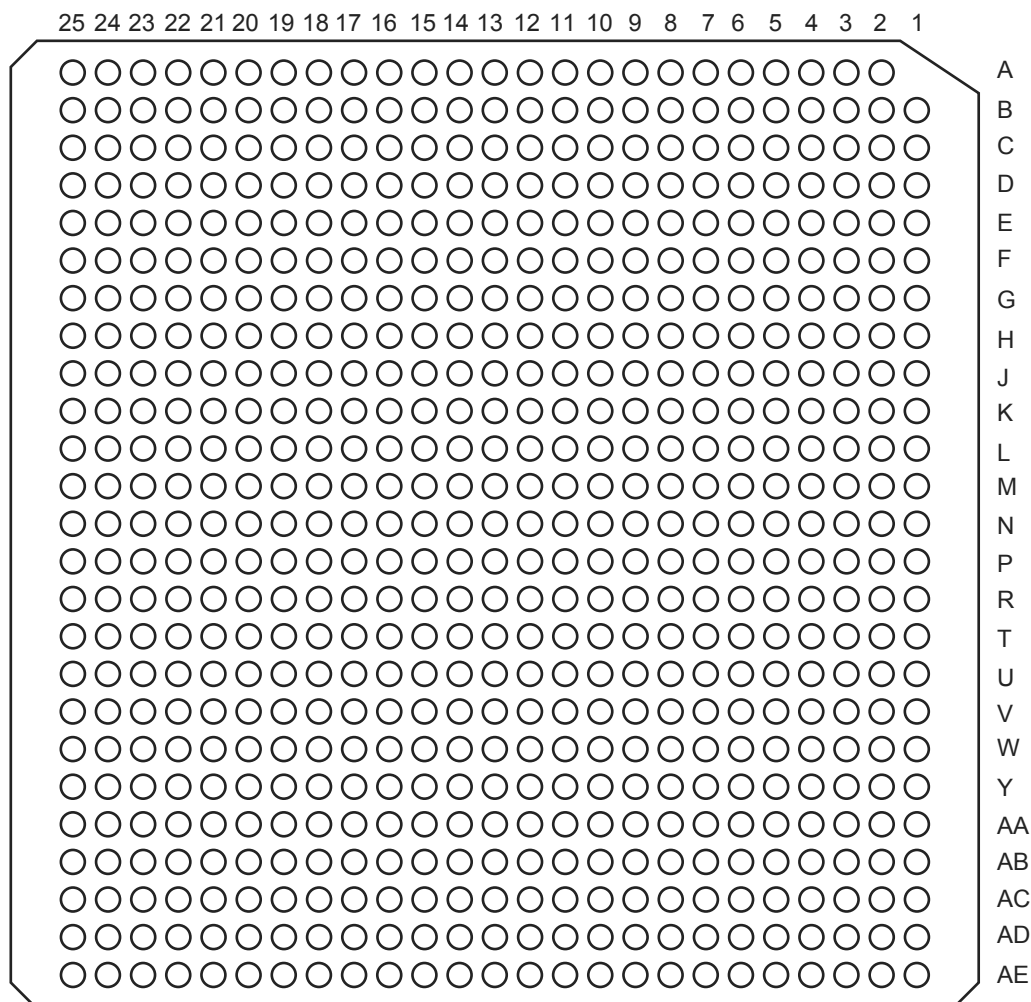
FG896	
AX2000 Function	Pin Number
IO19NB0F1	D11
IO19PB0F1	E11
IO20PB0F1	B8
IO21NB0F1	H12
IO21PB0F1	H11
IO23NB0F2	A10
IO23PB0F2	A9
IO25NB0F2	F12
IO25PB0F2	G12
IO26NB0F2	B11
IO26PB0F2	B10
IO27NB0F2	D12
IO27PB0F2	E12
IO28NB0F2	C12
IO28PB0F2	C11
IO30NB0F2	A12
IO30PB0F2	A11
IO31NB0F2	F13
IO31PB0F2	G13
IO33NB0F2	H13
IO33PB0F2	J13
IO34NB0F3	B13
IO34PB0F3	B12
IO37NB0F3	E14
IO37PB0F3	E13
IO38NB0F3	B14
IO38PB0F3	A14
IO39NB0F3	H14
IO39PB0F3	J14
IO40NB0F3	B15
IO40PB0F3	A15
IO41NB0F3/HCLKAN	C14
IO41PB0F3/HCLKAP	D14
IO42NB0F3/HCLKBN	E15
IO42PB0F3/HCLKBP	D15

FG896	
AX2000 Function	Pin Number
Bank 1	
IO43NB1F4/HCLKCN	E17
IO43PB1F4/HCLKCP	E16
IO44NB1F4/HCLKDN	C17
IO44PB1F4/HCLKDP	D17
IO45NB1F4	A16
IO45PB1F4	B16
IO47NB1F4	H17
IO47PB1F4	J17
IO48NB1F4	A17
IO48PB1F4	B17
IO49NB1F4	H18
IO49PB1F4	J18
IO51NB1F4	F18
IO51PB1F4	G18
IO52NB1F4	B18
IO53NB1F4	D18
IO53PB1F4	C18
IO55NB1F5	H19
IO55PB1F5	G19
IO56NB1F5	B19
IO56PB1F5	A19
IO57NB1F5	E20
IO57PB1F5	E19
IO58NB1F5	C20
IO58PB1F5	C19
IO59NB1F5	B20
IO59PB1F5	A20
IO61NB1F5	F20
IO61PB1F5	F19
IO62NB1F5	A22
IO62PB1F5	A21
IO63NB1F5	D21
IO63PB1F5	D20
IO65NB1F6	G20

CQ352	
AX2000 Function	Pin Number
VCCDA	346
VCCIB0	321
VCCIB0	333
VCCIB0	344
VCCIB1	273
VCCIB1	285
VCCIB1	297
VCCIB2	227
VCCIB2	239
VCCIB2	245
VCCIB2	257
VCCIB3	185
VCCIB3	197
VCCIB3	203
VCCIB3	215
VCCIB4	144
VCCIB4	156
VCCIB4	168
VCCIB5	96
VCCIB5	108
VCCIB5	120
VCCIB6	50
VCCIB6	62
VCCIB6	68
VCCIB6	80
VCCIB7	8
VCCIB7	20
VCCIB7	26
VCCIB7	38
VCCPLA	317
VCCPLB	315
VCCPLC	303
VCCPLD	301
VCCPLE	140
VCCPLF	138

CQ352	
AX2000 Function	Pin Number
VCCPLG	126
VCCPLH	124
VCOMPLA	318
VCOMPLB	316
VCOMPLC	304
VCOMPLD	302
VCOMPLE	141
VCOMPLF	139
VCOMPLG	127
VCOMPLH	125
VPUMP	267

CG624



Note

For Package Manufacturing and Environmental information, visit Resource center at <http://www.microsemi.com/soc/products/rescenter/package/index.html>.

CG624		CG624		CG624	
AX1000 Function	Pin Number	AX1000 Function	Pin Number	AX1000 Function	Pin Number
IO194NB6F18	Y3	IO215PB6F20	V4	IO237NB7F22	N8
IO194PB6F18	AA3	IO216NB6F20	P8	IO237PB7F22	N7
IO195NB6F18	V6	IO216PB6F20	R3	IO238NB7F22	M5
IO195PB6F18	W4	IO217NB6F20	P7	IO239NB7F22	L6
IO197NB6F18	R5	IO217PB6F20	R7	IO239PB7F22	L5
IO197PB6F18	U3	IO219NB6F20	R4	IO240NB7F22	M4
IO198NB6F18	P6	IO219PB6F20	T4	IO241NB7F22	L7
IO199NB6F18	Y5	IO220NB6F20	P2	IO241PB7F22	M7
IO199PB6F18	W5	IO220PB6F20	R2	IO242NB7F22	J3
IO200NB6F18	V3	IO221NB6F20	N4	IO243NB7F22	M9
IO200PB6F18	W3	IO221PB6F20	P4	IO243PB7F22	M8
IO201NB6F18	T7	IO223NB6F20	M2	IO244NB7F22	P9
IO201PB6F18	U7	IO223PB6F20	N2	IO244PB7F22	N6
IO202NB6F18	V2	IO224NB6F20	N3	IO245NB7F22	K8
IO203NB6F19	W2	IO224PB6F20	P3	IO245PB7F22	L8
IO203PB6F19	Y2	Bank 7		IO246NB7F22	F3
IO204NB6F19	AA1	IO225NB7F21	J2	IO246PB7F22	E3
IO204PB6F19	AB1	IO225PB7F21	J1	IO247NB7F23	K7
IO205NB6F19	R6	IO226PB7F21	G2	IO247PB7F23	K6
IO205PB6F19	T6	IO227NB7F21	H3	IO248NB7F23	D2
IO206NB6F19	W1	IO227PB7F21	H2	IO249NB7F23	G4
IO206PB6F19	Y1	IO229NB7F21	K2	IO249PB7F23	G3
IO207NB6F19	T2	IO229PB7F21	L2	IO251NB7F23	N10
IO207PB6F19	U2	IO230NB7F21	K1	IO251PB7F23	N9
IO208NB6F19	T1	IO230PB7F21	L1	IO253NB7F23	H4
IO208PB6F19	U1	IO231NB7F21	E2	IO253PB7F23	J4
IO209NB6F19	AA2	IO231PB7F21	F2	IO255NB7F23	J6
IO209PB6F19	AB2	IO232NB7F21	F1	IO255PB7F23	J5
IO210NB6F19	P5	IO232PB7F21	G1	IO257NB7F23	H5
IO211NB6F19	M1	IO233NB7F21	L3	IO257PB7F23	H6
IO211PB6F19	N1	IO233PB7F21	M3	Dedicated I/O	
IO212NB6F19	P1	IO234NB7F21	D1	GND	K5
IO212PB6F19	R1	IO234PB7F21	E1	GND	A18
IO213NB6F19	R8	IO235NB7F21	K4	GND	A2
IO213PB6F19	T8	IO235PB7F21	L4	GND	A24
IO215NB6F20	U4	IO236NB7F22	M6	GND	A25

Revision	Changes	Page
Revision 17 (continued)	The C180 package was removed from product tables and the "Package Pin Assignments" section (PDN 0909).	3-1
	Package names used in the "Axcelerator Family Product Profile" and "Package Pin Assignments" section were revised to match standards given in <i>Package Mechanical Drawings</i> (SAR 27395).	i, 3-1
	The "Introduction" section for "User I/Os" was updated as follows: "The user does not need to assign VREF pins for OUTBUF and TRIBUF. VREF pins are needed only for input and bidirectional I/Os" (SARs 24181, 24309).	2-11
	Power values in Table 2-4 • Default CLOAD/VCCI were updated to reflect those of SmartPower (SAR 33945).	2-3
	Two parameter names were corrected in Figure 2-10 • Output Buffer Delays. One occurrence of t_{ENLZ} was changed to t_{ENZL} and one occurrence of t_{ENHZ} was changed to t_{ENZH} (SAR 33890).	2-22
	The "Timing Model" section was updated with new timing values. Timing tables in the "I/O Specifications" section were updated to include enable paths. Values in the timing tables in the "Voltage-Referenced I/O Standards" section and "Differential Standards" section were updated. Table 2-63 • R-Cell was updated (SAR 33945).	2-8, 2-26 to 2-53
	Figure 2-11 • Timing Model was replaced (SAR 33043).	2-23
	The timing tables for "RAM" and "FIFO" were updated (SAR 33945).	2-90 to 2-106
	"Data Registers (DRs)" values were modified for IDCODE and USERCODE (SARs 18257, 26406).	2-108
Revision 16 (v2.8, Oct. 2009)	The package diagram for the "CQ208" package was incorrect and has been replaced with the correct diagram (SARs 23865, 26345).	3-89
	The datasheet was updated to include AX2000-CQ2526 information.	N/A
	MIL-STD-883 Class B is no longer supported by Axcelerator FPGAs and as a result was removed.	N/A
Revision 15 (v2.7, Nov. 2008)	A footnote was added to the "Introduction" in the "Axcelerator Clock Management System" section.	2-75
	RoHS-compliant information was added to the "Ordering Information".	ii
Revision 14 (v2.6)	ACTgen was changed to SmartGen because ACTgen is obsolete.	N/A
	In Table 2-4, the units for the P_{LOAD} , P_{10} , and $P_{I/O}$ were updated from mW/MHz to mW/MHz.	2-3
	In the "Pin Descriptions" section, the HCLK and CLK descriptions were updated to include tie-off information.	2-9
	The "Global Resource Distribution" section was updated.	2-70
Revision 13 (v2.5)	The "CG624" table was updated.	3-116
	A note was added to Table 2-2.	2-1
Revision 13 (v2.5)	In the "Package Thermal Characteristics", the temperature was changed from 150°C to 125°C.	2-6